

NC7ST32

TinyLogic HST 2-Input OR Gate

Description

The NC7ST32 is a single 2-Input high performance CMOS OR Gate, with TTL-compatible inputs. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation. ESD protection diodes inherently guard both inputs and output with respect to the V_{CC} and GND rails. High gain circuitry offers high noise immunity and reduced sensitivity to input edge rate. The TTL-compatible inputs facilitate TTL to NMOS / CMOS interfacing. Device performance is similar to MM74HCT but with $1/2$ the output current drive of HC / HCT.

Features

- Space Saving SC-74A and SC-88A 5-Lead Package
- Ultra Small MicroPak™ Leadless Package
- High Speed: $t_{PD} < 7$ ns Typ, $V_{CC} = 5$ V, $C_L = 15$ pF
- Low Quiescent Power: $I_{CC} < 1$ μ A Typ, $V_{CC} = 5.5$ V
- Balanced Output Drive: 2 mA I_{OL} , -2 mA I_{OH}
- TTL-compatible Inputs
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

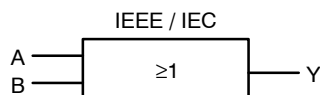


Figure 1. Logic Symbol



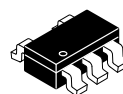
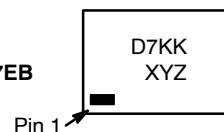
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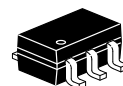
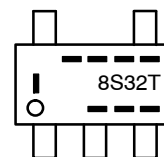
MARKING DIAGRAMS



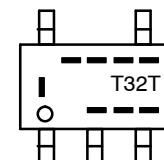
**SIP6
CASE 127EB**



**SC-74A
CASE 318BQ**



**SC-88A
CASE 419AC-01**



D7, 8S32, T32 = Specific Device Code
 KK = 2-Digit Lot Run Traceability Code
 XY = 2-Digit Date Code Format
 Z = Assembly Plant Code
 T = Die Run Code
 --- = Year Coding Scheme
 !- = Plant Code Identifier
 --- = Eight-Week Datacoding Scheme

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 4 of this data sheet.

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Pin Configurations

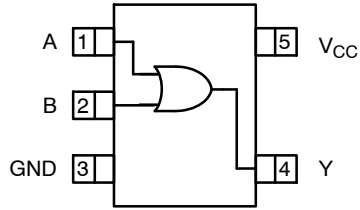


Figure 2. SC-88A and SC-74A (Top View)

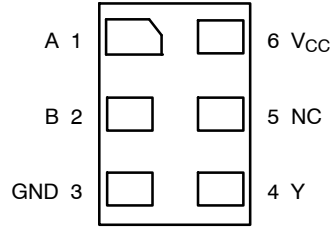


Figure 3. MicroPak (Top Through View)

PIN DESCRIPTIONS

Pin Name	Description
A, B	Inputs
Y	Output
NC	No Connect

FUNCTION TABLE (Y = A + B)

Inputs		Output
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	H

H = HIGH Logic Level
L = LOW Logic Level

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Min	Max	Unit
V _{CC}	Supply Voltage		-0.5	6.5	V
I _{IK}	DC Input Diode Current	V _{IN} < -0.5 V	-	-20	mA
		V _{IN} ≥ V _{CC} + 0.5 V	-	+20	
V _{IN}	DC Input Voltage		-0.5	V _{CC} + 0.5	V
I _{OK}	DC Output Diode Current	V _{OUT} < -0.5 V	-	-20	mA
		V _{OUT} > V _{CC} + 0.5 V	-	+20	
V _{OUT}	Output Voltage		-0.5	V _{CC} + 0.5	V
I _{OUT}	DC Output Source or Sink Current		-	±12.5	mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current per Supply Pin		-	±25	mA
T _{STG}	Storage Temperature		-65	+150	°C
T _J	Junction Temperature		-	+150	°C
T _L	Lead Temperature (Soldering, 10 Seconds)		-	+260	°C
P _D	Power Dissipation in Still Air	SC-74A	-	225	mW
		SC-88A	-	190	
		MicroPak	-	327	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	Supply Voltage		4.5	5.5	V
V_{IN}	Input Voltage		0	V_{CC}	V
V_{OUT}	Output Voltage		0	V_{CC}	V
T_A	Operating Temperature		-40	+85	°C
t_r, t_f	Input Rise and Fall Time	$V_{CC} = 5.0\text{ V}$	0	500	ns
θ_{JA}	Thermal Resistance	SC-74A	-	555	°C/W
		SC-88A	-	659	
		MicroPak	-	382	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. Unused inputs must be held HIGH or LOW. They may not float.

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	Conditions	$T_A = +25^\circ\text{C}$			$T_A = -40\text{ to }+85^\circ\text{C}$		Unit
				Min	Typ	Max	Min	Max	
V_{IH}	HIGH Level Input Voltage	4.5 – 5.5		2.0	-	-	2.0	-	V
V_{IL}	LOW Level Input Voltage	4.5 – 5.5		-	-	0.8	-	0.8	V
V_{OH}	HIGH Level Output Voltage	4.5	$I_{OH} = -20\text{ }\mu\text{A}, V_{IN} = V_{IH}$	4.4	4.5	-	4.4	-	V
		4.5	$I_{OH} = -2\text{ mA}$	4.18	4.35	-	4.13	-	
V_{OL}	LOW Level Output Voltage	4.5	$I_{OL} = 20\text{ }\mu\text{A}, V_{IN} = V_{IL}$	-	0	0.1	-	0.1	V
		4.5	$I_{OL} = 2\text{ mA}$	-	0.10	0.26	-	0.33	
I_{IN}	Input Leakage Current	5.5	$1.65 \leq V_{IN} \leq 5.5\text{ V}$	-	-	± 0.1	-	± 1.0	μA
I_{CC}	Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND	-	-	1.0	-	10.0	μA
I_{CCT}	I_{CC} per Input	5.5	One Input $V_{IN} = 0.5\text{ V}$ or 2.4 V , Other Input V_{CC} or GND	-	-	2.0	-	2.9	mA

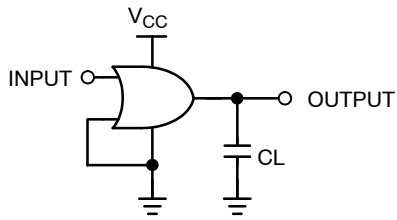
AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	Conditions	$T_A = +25^\circ\text{C}$			$T_A = -40\text{ to }+85^\circ\text{C}$		Unit
				Min	Typ	Max	Min	Max	
t_{PLH}, t_{PHL}	Propagation Delay (Figure 4, 6)	5.0	$C_L = 15\text{ pF}$	-	4.3	12	-	-	ns
				-	6.1	17	-	-	
		4.5	$C_L = 50\text{ pF}$	-	6.5	16	-	20	
				-	12	27	-	31	
		5.5	$C_L = 50\text{ pF}$	-	5.4	14	-	18	
				-	10.7	26	-	30	
t_{TLH}, t_{THL}	Output Transition Time (Figure 4, 6)	5.0	$C_L = 15\text{ pF}$	-	4	10	-	-	ns
		4.5	$C_L = 50\text{ pF}$	-	11	25	-	31	
		5.5	$C_L = 50\text{ pF}$	-	10	21	-	26	
C_{IN}	Input Capacitance	Open		-	2	10	-	-	pF
C_{PD}	Power Dissipation Capacitance (Figure 5)	5.0	(Note 2)	-	6	-	-	-	pF

2. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current. Current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 5) C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CCstatic})$.

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AC Loading and Waveforms



C_L includes load and stray capacitance
Input PRR = 1.0 MHz; t_W = 500 ns

Figure 4. AC Test Circuit

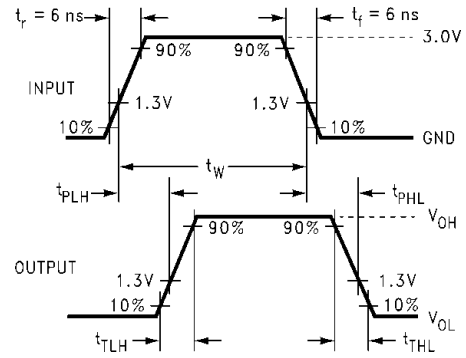
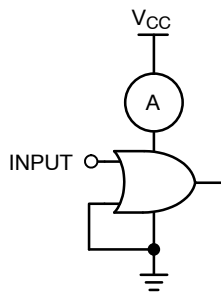


Figure 6. AC Waveforms



Input = AC Waveform;
PRR = Variable; Duty Cycle = 50%.

Figure 5. I_{CCD} Test Circuit

ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping [†]
NC7ST32M5X	8S32	SC-74A	3000 / Tape & Reel
NC7ST32P5X	T32	SC-88A	3000 / Tape & Reel
NC7ST32L6X	D7	SIP6, MicroPak	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

2X

0.05 C

1.45

B

2X

0.05 C

1.00

(0.254)

PIN 1 IDENTIFIER

5

TOP VIEW

0.50±0.05

0.05

0.00

C

0.30±0.05 5X

0.20±0.05 6X

1.0

1.45±0.05

1.00±0.05

0.35±0.05 5X

0.5

(0.050) 6X

(0.125) 4X

0.10(M) C B A

0.05(M) C

0.30±0.05 5X

0.35±0.05 5X

0.40±0.05

0.075 X 45° CHAMFER

DETAIL A

DETAIL A

PIN 1 TERMINAL

RECOMMENDED LAND PATTERN

(1)

(0.49)

5X

(0.52)

1X

(0.30)

6X

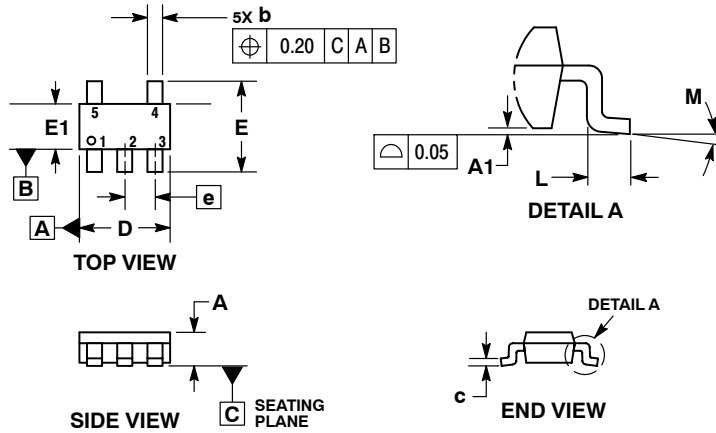
(0.75)

1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-2009
4. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.

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PACKAGE DIMENSIONS

SC-74A CASE 318BQ ISSUE B

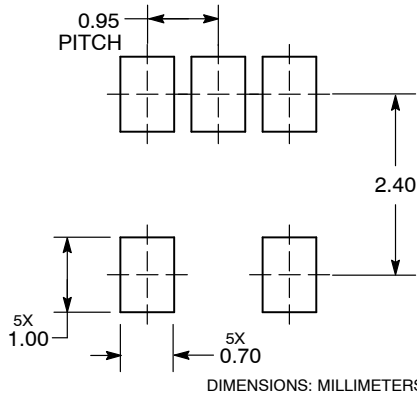


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

MILLIMETERS		
DIM	MIN	MAX
A	0.90	1.10
A1	0.01	0.10
b	0.25	0.50
c	0.10	0.26
D	2.85	3.15
E	2.50	3.00
E1	1.35	1.65
e	0.95 BSC	
L	0.20	0.60
M	0°	10°

RECOMMENDED SOLDERING FOOTPRINT*



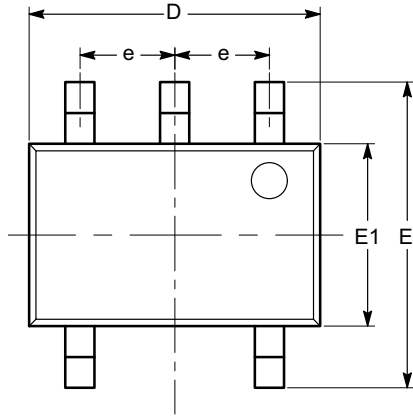
DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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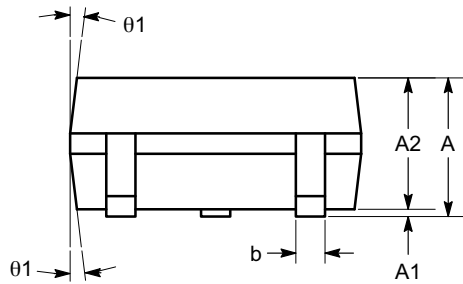
PACKAGE DIMENSIONS

SC-88A (SC-70 5 Lead), 1.25x2
CASE 419AC-01
ISSUE A

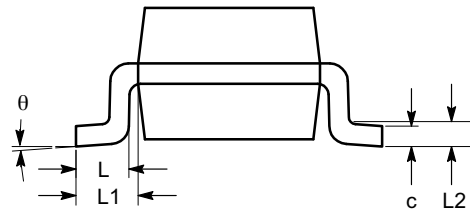


TOP VIEW

SYMBOL	MIN	NOM	MAX
A	0.80		1.10
A1	0.00		0.10
A2	0.80		1.00
b	0.15		0.30
c	0.10		0.18
D	1.80	2.00	2.20
E	1.80	2.10	2.40
E1	1.15	1.25	1.35
e	0.65 BSC		
L	0.26	0.36	0.46
L1	0.42 REF		
L2	0.15 BSC		
θ	0°		8°
$\theta 1$	4°		10°



SIDE VIEW




END VIEW

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-203.

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